

FCH65S16D1Q

eSiC Silicon Carbide Schottky Diode

650V, 16A



Description

The 650V eSiC is an advanced Faster Semiconductor's silicon carbide diode family. This technology combines the benefits of excellent low capacitive charge and robustness. Consequently, the eSiC family is suitable for application requiring high power efficiency.

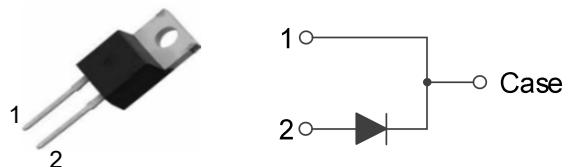
Applications

- Power Factor Correction
- Industrial Power Supplies
- Solar Inverter, UPS

Features

V _{RRM}	I _F	T _{J,max}	Q _c
650 V	16 A	175 °C	47 nC

- No reverse recovery current
- Low capacitive charge
- 175°C Max junction temperature
- High surge current capability
- Switching behavior independent of temperature
- Pb-Free, Halogen Free and RoHS compliant



Absolute Maximum Ratings ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter		Value	Unit
V _{RRM}	Repetitive Peak Reverse Voltage		650	V
I _F	Forward Current	$T_C=128^\circ\text{C}$	16	A
I _{F,SM}	Non-Repetitive Forward Surge Current	$T_C=25^\circ\text{C}, t_p=10 \text{ ms}$	73	A
		$T_C=150^\circ\text{C}, t_p=10 \text{ ms}$	62.1	A
I _{F,Max}	Non-Repetitive Peak Forward Current	$T_C=25^\circ\text{C}, t_p=10 \text{ us}$	690	A
		$T_C=150^\circ\text{C}, t_p=10 \text{ us}$	587	A
I ² dt value	$\int I^2 dt$	$T_C=25^\circ\text{C}, t_p=10 \text{ ms}$	26.6	A ² s
		$T_C=150^\circ\text{C}, t_p=10 \text{ ms}$	19.2	A ² s
P _{tot}	Power Dissipation	$T_C=25^\circ\text{C}$	107	W
T _J , T _{STG}	Operating Junction and Storage Temperature		-55 to +175	°C

Thermal Characteristics

Symbol	Parameter	Value	Unit
R _{θJC}	Thermal Resistance, Junction to Case, Max.	1.4	°C/W

Package Marking and Ordering Information

Part Number	Top Marking	Package	Packing Method	Quantity
FCH65S16D1Q	FCH65S16D1Q	TO-220-2L	Tube	50 units

Electrical Characteristics ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V_F	Forward Voltage	$I_F=16 \text{ A}, T_C=25^\circ\text{C}$		1.40	1.7	V
		$I_F=16 \text{ A}, T_C=175^\circ\text{C}$		1.55	-	
I_R	Reverse Current	$V_R=650 \text{ V}, T_C=25^\circ\text{C}$		-	100	μA
		$V_R=650 \text{ V}, T_C=175^\circ\text{C}$		-	300	
Q_C	Total Capacitive Charge	$V_R=400 \text{ V}, T_C=25^\circ\text{C}$		47		nC
C	Total Capacitance	$V_R=1 \text{ V}, f=100 \text{ kHz}$		755		pF
		$V_R=400 \text{ V}, f=100 \text{ kHz}$		74		
E_C	Capacitance Stored Energy	$V_R=400 \text{ V}, T_C=25^\circ\text{C}$		6.9		μJ

Typical Performance Characteristics

Figure 1. Power Derating

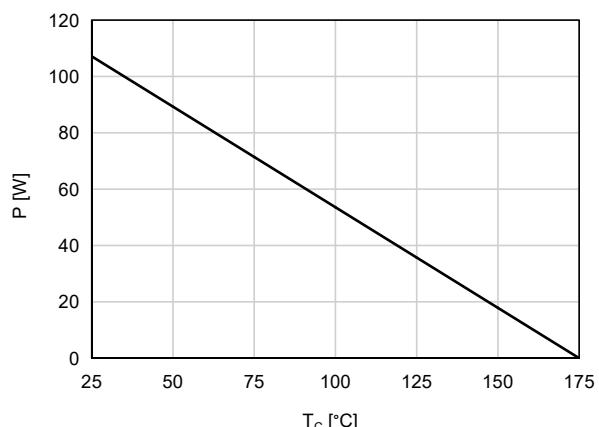


Figure 2. Current Derating

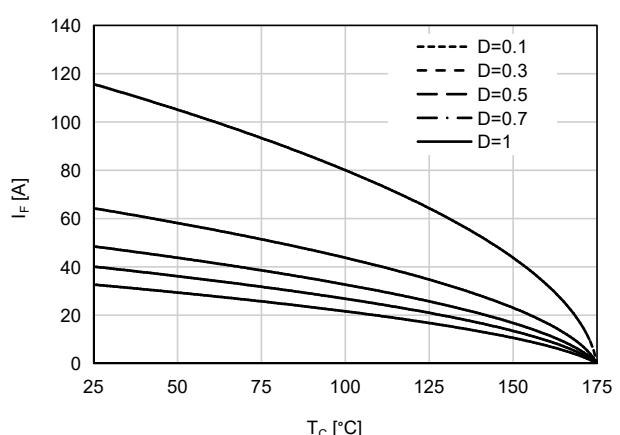


Figure 3. Forward Characteristics

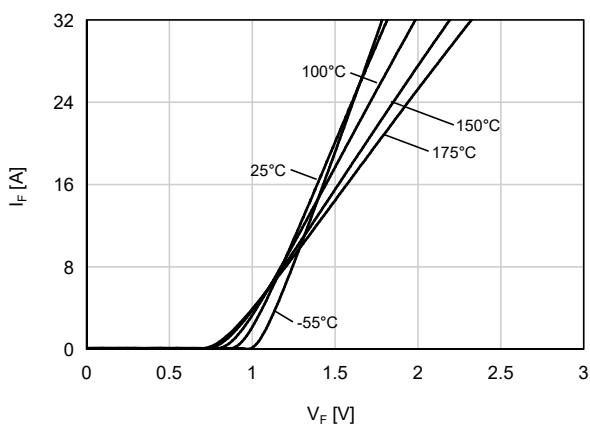


Figure 4. Reverse Characteristics

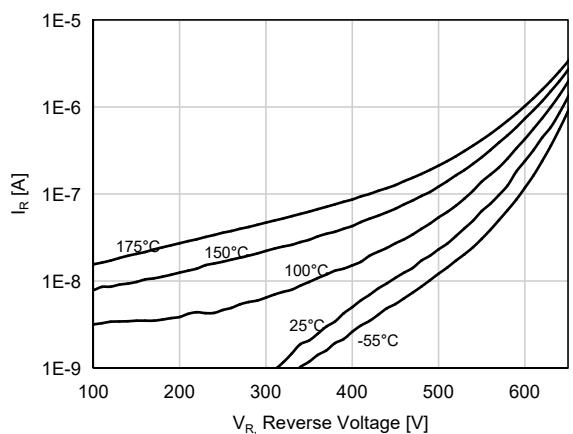


Figure 5. Capacitive Charge Characteristic

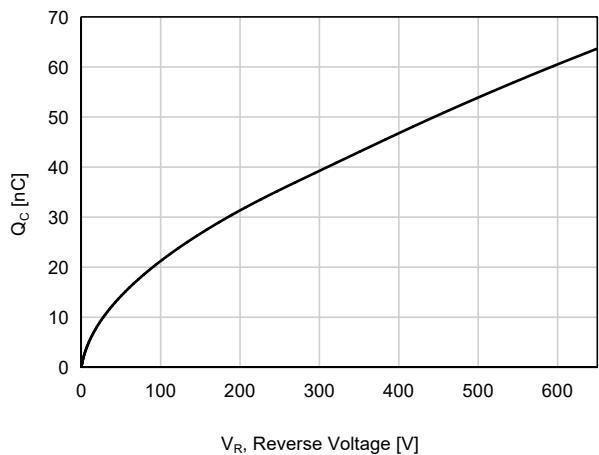
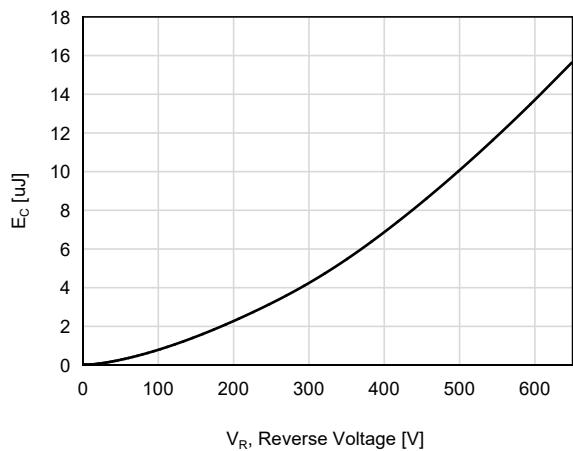
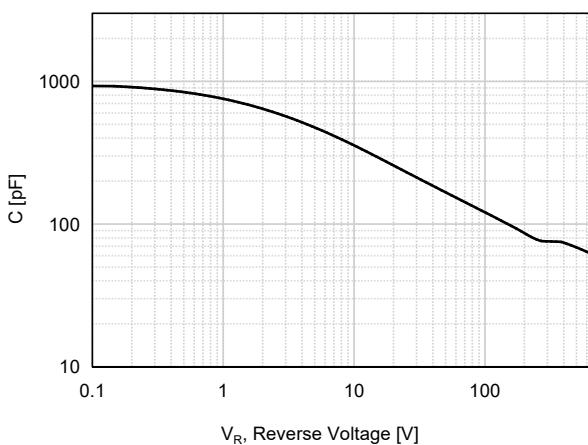
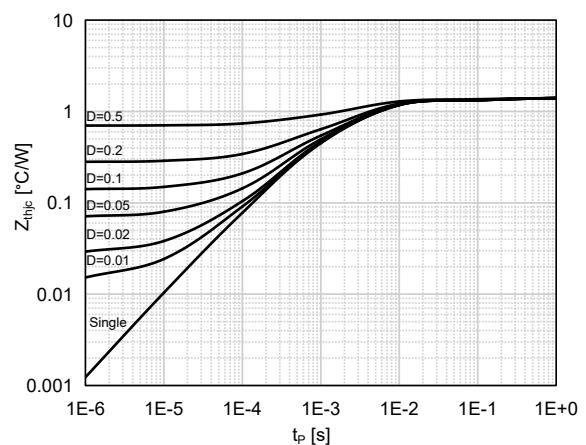


Figure 6. Capacitance Stored Energy

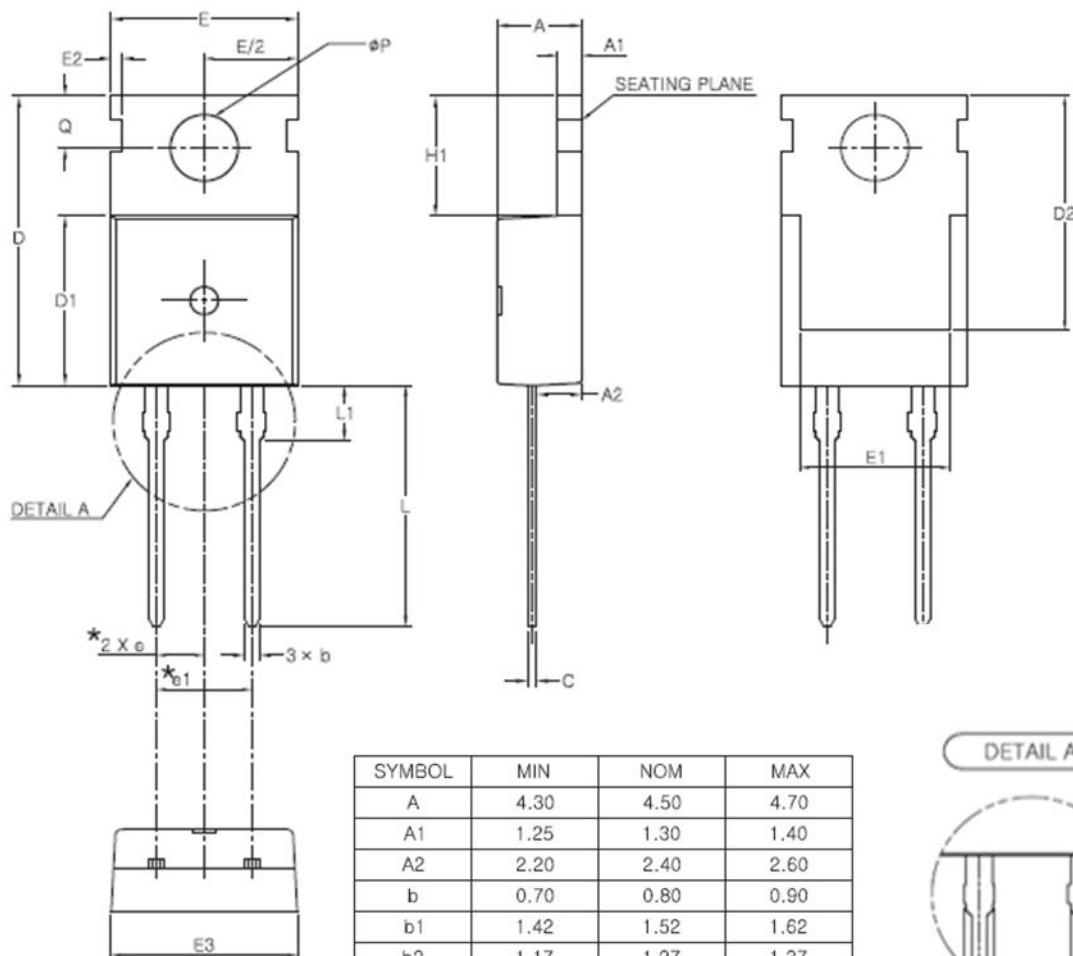


Typical Performance Characteristics**Figure 7. Capacitance Characteristic****Figure 8. Transient Thermal Response Curve**

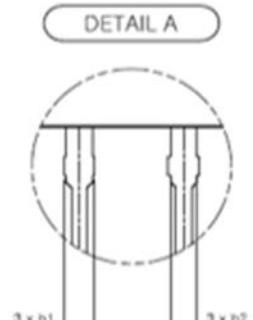
Package Outlines

TO-220-2L

TO-220-2L



SYMBOL	MIN	NOM	MAX
A	4.30	4.50	4.70
A1	1.25	1.30	1.40
A2	2.20	2.40	2.60
b	0.70	0.80	0.90
b1	1.42	1.52	1.62
b2	1.17	1.27	1.37
c	0.45	0.50	0.60
D	15.50	15.70	15.90
D1	9.00	9.20	9.40
D2	(12.70)		
E	9.70	9.90	10.10
E1	(8.00)		
E2	(0.60)		
E3	9.70	9.90	10.10
e	2.54 BSC		
e1	5.08 BSC		
H1	6.30	6.50	6.70
L	12.88	13.08	13.28
L1	(3.00)		
φP	3.50	3.60	3.70
Q	2.70	2.80	2.90



* Dimensions in millimeters